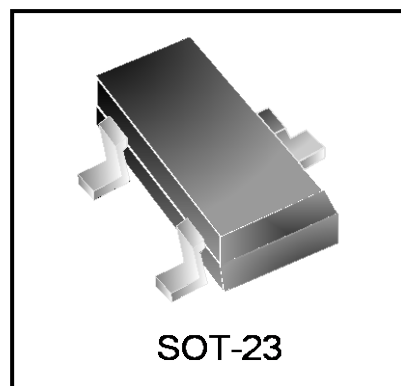


Features

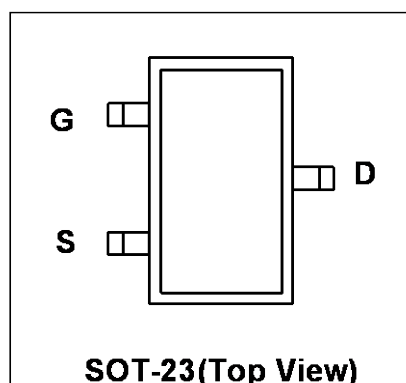
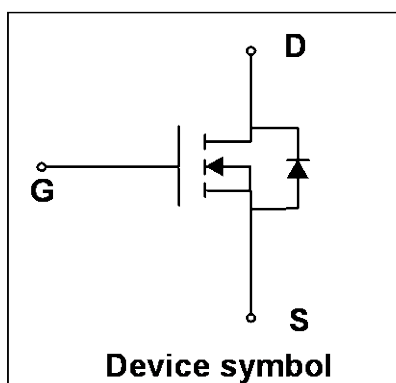
- Way-on Small Signal MOSFETs
- $V_{DS} = 30\text{ V}$, $I_D = 5.8\text{ A}$
 $R_{DS(on)} < 36\text{ m}\Omega$ @ $V_{GS} = 10\text{ V}$
 $R_{DS(on)} < 45\text{ m}\Omega$ @ $V_{GS} = 4.5\text{ V}$
- Trench LV MOSFET Technology

Mechanical Characteristics

- SOT-23 Package
- Marking : Making Code
- RoHS Compliant



Schematic & PIN Configuration



Absolute Maximum Rating ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Parameter		Symbol	Value	Unit
Drain-Source Voltage		V_{DS}	30	V
Gate-Source Voltage		V_{GS}	± 20	V
Continuous Drain Current	$T_A = 25^\circ\text{C}$	I_D	5.8	A
Pulsed Drain Current ¹		I_{DM}	30	A
Power Dissipation		P_D	1.2	W
Operating Junction and Storage Temperature Range		T_J, T_{STG}	-55 to 150	$^\circ\text{C}$

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance from Junction to Ambient ²	$R_{\theta JA}$	104	$^\circ\text{C/W}$

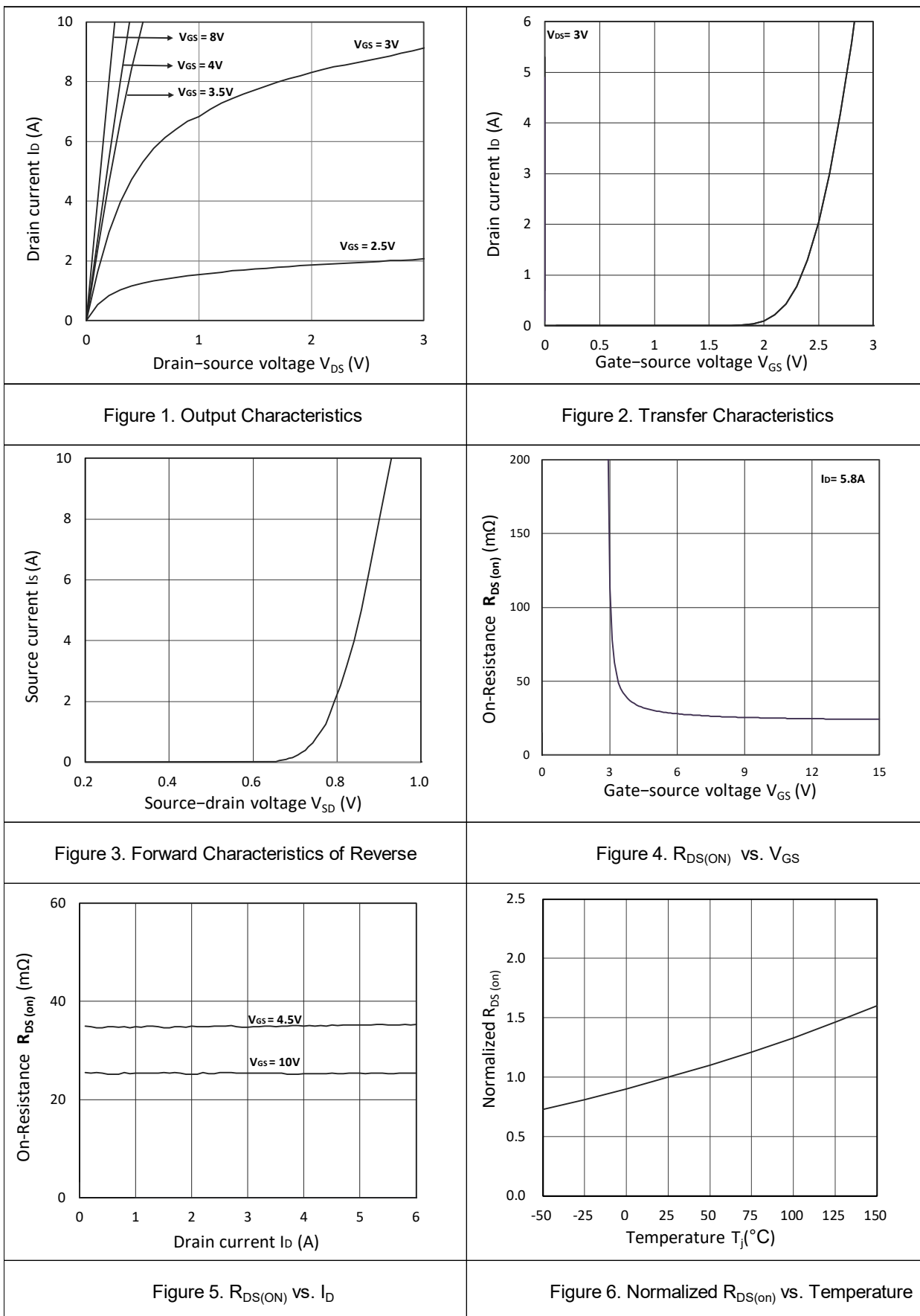
Electrical Characteristics ($T_J=25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} = 0 V, I _D = 250μA	30	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =30V, V _{GS} = 0 V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} = ±20V	-	-	±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{GS} = V _{DS} , I _D = 250μA	1	1.5	2.5	V
Drain-Source on-State Resistance ³	R _{DS(on)}	V _{GS} = 10V, I _D = 5.8A	-	25	36	mΩ
		V _{GS} = 4.5V, I _D = 4.8A	-	35	45	
Dynamic Characteristics ⁴						
Input Capacitance	C _{iss}	V _{GS} = 0V, V _{DS} = 15V, f = 1MHz	-	500	-	pF
Output Capacitance	C _{oss}		-	72	-	
Reverse Transfer Capacitance	C _{rss}		-	58	-	
Switching Characteristics ⁴						
Total Gate Charge	Q _g	V _{DS} = 15V, V _{GS} = 4.5V, I _D = 5.8A	-	7.5	-	nC
Gate–Source Charge	Q _{gs}		-	1.6	-	
Gate–Drain Charge	Q _{gd}		-	2.1	-	
Turn-on Delay Time	t _{d(on)}	V _{DD} = 15V, V _{GS} = 10V, R _{GEN} =6Ω, R _L =2.6Ω	-	6.4	-	ns
Turn-on Rise Time	t _r		-	3.1	-	
Turn-off Delay Time	t _{d(off)}		-	15.0	-	
Turn- off Fall Time	t _f		-	2.6	-	
Source-Drain Diode Characteristics						
Body Diode Voltage ³	V _{SD}	I _S =1A, V _{GS} = 0V	-	-	1	V
Continuous Source Current	I _S		-	-	5.8	A

Notes:

1. Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)} = 150^{\circ}\text{C}$
2. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper, The value in any given application depends on the user's specific board design.
3. Pulse Test: Pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$.
4. This value is guaranteed by design hence it is not included in the production test.

Typical Characteristics



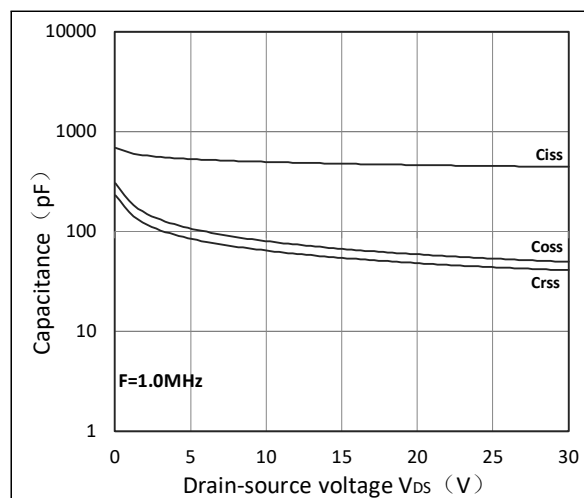


Figure 7. Capacitance Characteristics

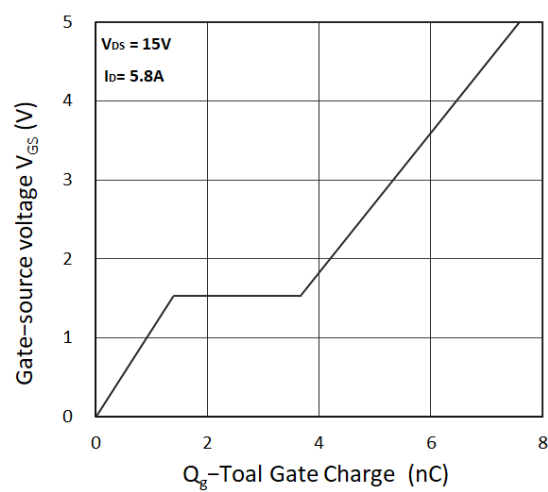
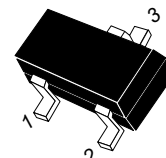
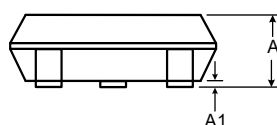
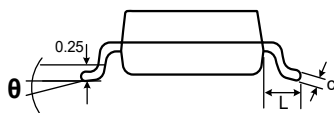
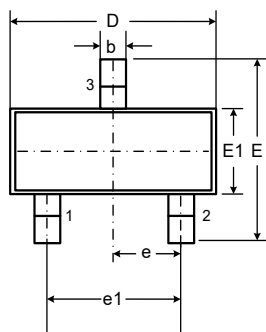


Figure 8. Gate Charge Characteristics

Outline Drawing – SOT-23

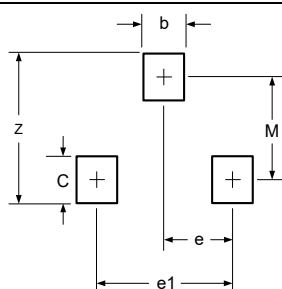
PACKAGE OUTLINE



SOT-23

DIMENSIONS

SYMBOL	MILLIMETER		INCHES	
	MIN	MAX	MIN	MAX
A	0.90	1.15	0.035	0.045
A1	0.00	0.10	0.000	0.004
b	0.30	0.50	0.012	0.020
c	0.08	0.15	0.003	0.006
D	2.80	3.00	0.110	0.118
E	2.25	2.55	0.089	0.100
E1	1.20	1.40	0.047	0.055
e	0.95 BSC		0.037BSC	
e1	1.80	2.00	0.071	0.079
L	0.55REF		0.022REF	
θ	0°	8°	0°	8°



DIMENSIONS		
DIM	INCHES	MILLIMETERS
M	0.080	2.02
C	0.032	0.80
Z	0.111	2.82
e	0.037 BSC	0.95 BSC
e1	0.075 BSC	1.90 BSC
b	0.032	0.80

Notes

1. Dimensioning and tolerances per ANSI Y14.5M, 1985.
2. Controlling Dimension: Inches
3. Pin 3 is the cathode (Unidirectional Only).
4. Dimensions are exclusive of mold flash and metal burrs.

Marking Codes

Part Number	WM03N57M
Marking Code	

Package Information

Qty: 3k/Reel

CONTACT INFORMATION

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For additional information, please contact your local Sales Representative.

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Specifications are subject to change without notice.

The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time. Users should verify actual device performance in their specific applications.